HEF4521B

24-stage frequency divider and oscillator Rev. 6 — 21 November 2011

Product data sheet

1. **General description**

The HEF4521B consists of a chain of 24 toggle flip-flops with an overriding asynchronous master reset input (MR), and an input circuit that allows three modes of operation. The single inverting stage (A2 to Y2) functions as: a crystal oscillator, an input buffer for an external oscillator or in combination with A1 as an RC oscillator. The crystal oscillator operates in Low-power mode when pins V_{SS1} and V_{DD1} are supplied via external resistors.

Each flip-flop divides the frequency of the previous flip-flop by two, consequently the HEF4521B counts up to 2^{24} = 16777216. The counting advances on the HIGH-to-LOW transition of the clock (A2). The outputs from each of the last seven stages (218 to 224) are available for additional flexibility.

It operates over a recommended V_{DD} power supply range of 3 V to 15 V referenced to V_{SS} (usually ground). Unused inputs must be connected to V_{DD} , V_{SS} , or another input.

Features and benefits 2.

- Low power crystal oscillator operation
- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from -40 °C to +85 °C
- Complies with JEDEC standard JESD 13-B

3. Ordering information

Ordering information

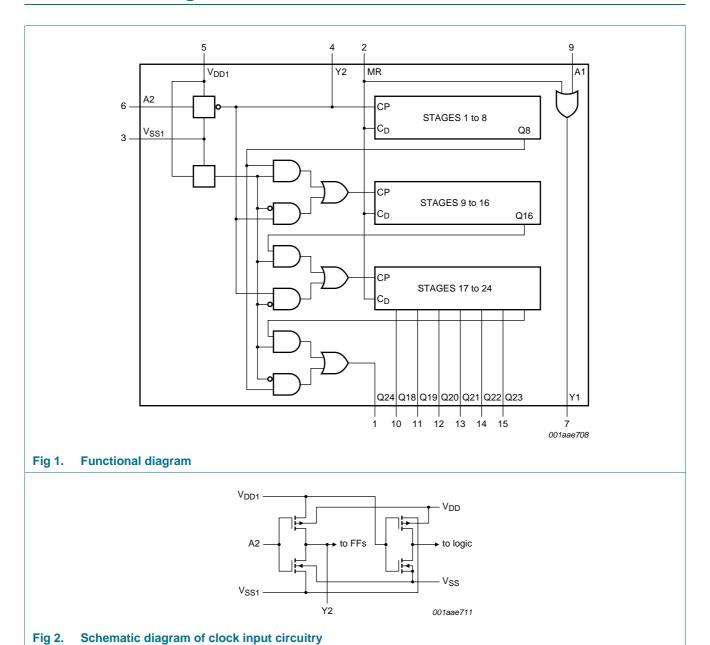
All types operate from -40 °C to +85 °C.

Type number	Package								
	Name	Description	Version						
HEF4521BP	DIP16	plastic dual in-line package; 16-leads (300 mil)	SOT38-4						
HEF4521BT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1						

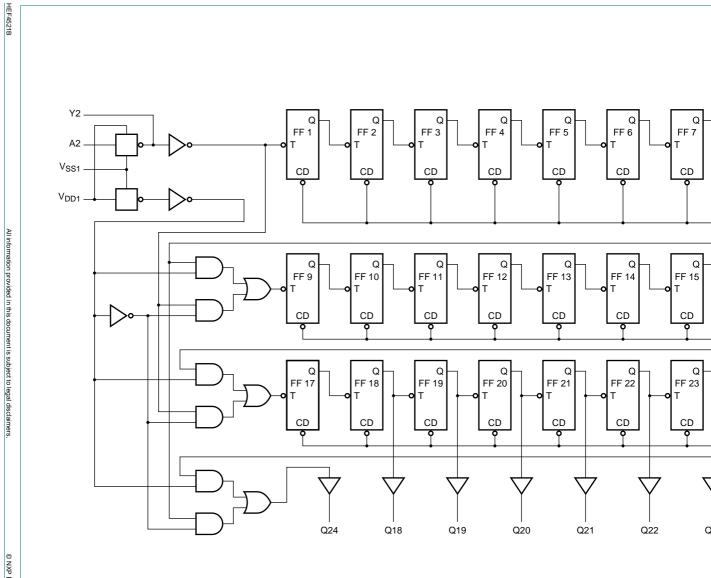


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4. Functional diagram



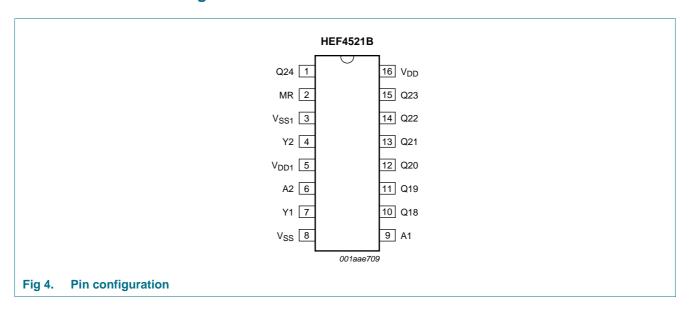
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5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol Pin Description MR 2 master reset input V _{SS1} 3 ground supply voltage 1 V _{DD1} 5 supply voltage 1 Y1, Y2 7, 4 external oscillator connection V _{SS} 8 ground supply voltage A1, A2 9, 6 external oscillator connection Q18 to Q24 10, 11, 12, 13, 14, 15, 1 output V _{DD} 16 supply voltage		· ·	
V _{SS1} 3 ground supply voltage 1 V _{DD1} 5 supply voltage 1 Y1, Y2 7, 4 external oscillator connection V _{SS} 8 ground supply voltage A1, A2 9, 6 external oscillator connection Q18 to Q24 10, 11, 12, 13, 14, 15, 1 output	Symbol	Pin	Description
VDD15supply voltage 1Y1, Y27, 4external oscillator connectionVSS8ground supply voltageA1, A29, 6external oscillator connectionQ18 to Q2410, 11, 12, 13, 14, 15, 1output	MR	2	master reset input
Y1, Y2 7, 4 external oscillator connection Vss 8 ground supply voltage A1, A2 9, 6 external oscillator connection Q18 to Q24 10, 11, 12, 13, 14, 15, 1 output	V _{SS1}	3	ground supply voltage 1
V _{SS} 8 ground supply voltage A1, A2 9, 6 external oscillator connection Q18 to Q24 10, 11, 12, 13, 14, 15, 1 output	V _{DD1}	5	supply voltage 1
A1, A2 9, 6 external oscillator connection Q18 to Q24 10, 11, 12, 13, 14, 15, 1 output	Y1, Y2	7, 4	external oscillator connection
Q18 to Q24 10, 11, 12, 13, 14, 15, 1 output	V _{SS}	8	ground supply voltage
	A1, A2	9, 6	external oscillator connection
V _{DD} 16 supply voltage	Q18 to Q24	10, 11, 12, 13, 14, 15, 1	output
	V_{DD}	16	supply voltage

6. Count capacity

Table 3. Count capacity

Output	Count capacity
Q18	2 ¹⁸ = 262144
Q19	2 ¹⁹ = 524288
Q20	2 ²⁰ = 1048576
Q21	$2^{21} = 2097152$
Q22	2 ²² = 4194304
Q23	2 ²³ = 8388608
Q24	2 ²⁴ = 16777216

HEF4521E

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7. Functional test

A test function has been included to reduce the test time required to test all 24 counter stages. This test function divides the counter into three 8-stage sections by connecting V_{SS1} to V_{DD} and V_{DD1} to V_{SS} . 255 counts are loaded into each of the 8-stage sections in parallel via A2 (connected to Y2). All flip-flops are now at a HIGH level. The counter is now returned to the normal 24-stage in series configuration by connecting V_{SS1} to V_{SS} and V_{DD1} to V_{DD} . Entering one more pulse into input A2 causes the counter to ripple from an all HIGH state to an all LOW state.

Table 4. Functional test sequence[1]

Input	S	Contro	Control terminals			Remarks
MR	A2 Y2 V _{SS1} V _{DD1} Q18 to		Y2 V _{SS1} V _{DD1} Q18 to Q24			
Н	L	L	V_{DD}	V_{SS}	L	counter is in three 8-stage sections in parallel mode; A2 and Y2 are interconnected (Y2 is now input); counter is reset by MR.
L	[2]	[2]	V_{DD}	V_{SS}	Н	
L	L	L	V_{SS}	V_{SS}	Н	V _{SS1} is connected to V _{SS} .
L	Н	L	V_{SS}	V_{SS}	Н	the input A2 is made HIGH.
L	Н	L	V_{SS}	V_{DD}	Н	V_{DD1} is connected to V_{DD} ; Y2 is now made floating and becomes an output; the device is now in the 2^{24} mode.
L	\downarrow		V_{SS}	V_{DD}	L	counter ripples from an all HIGH state to an all LOW state.

^[1] H = HIGH voltage level; L = LOW voltage level; $\downarrow = HIGH$ to LOW transition.

8. Limiting values

Table 5. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DD}	supply voltage		-0.5	+18	V
I _{IK}	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{DD} + 0.5 \text{ V}$	-	±10	mA
V_{I}	input voltage		-0.5	$V_{DD} + 0.5$	V
I _{OK}	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{DD} + 0.5 \text{ V}$	-	±10	mA
I _{I/O}	input/output current		-	±10	mA
I_{DD}	supply current	to any supply terminal	-	±100	mA
T_{stg}	storage temperature		-65	+150	°C
T _{amb}	ambient temperature		-40	+85	°C
P _{tot}	total power dissipation	DIP16 package	<u>[1]</u> -	750	mW
		SO16 package	[2] _	500	mW
Р	power dissipation	per output	-	100	mW

^[1] For DIP16 package: P_{tot} derates linearly with 12 mW/K above 70 °C.

^{[2] 255} pulses are clocked into A2, Y2. The counter advances on the LOW to HIGH transition.

^[2] For SO16 package: P_{tot} derates linearly with 8 mW/K above 70 °C.

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9. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{DD}	supply voltage		3	-	15	V
VI	input voltage		0	-	V_{DD}	V
T _{amb}	ambient temperature	in free air	-40	-	+85	°C
Δt/ΔV	input transition rise and fall rate	$V_{DD} = 5 V$	-	-	3.75	μs/V
		$V_{DD} = 10 \text{ V}$	-	-	0.5	μs/V
		V _{DD} = 15 V	-	-	0.08	μs/V

10. Static characteristics

Table 7. Static characteristics

 $V_{SS} = 0$ V; $V_I = V_{SS}$ or V_{DD} unless otherwise specified.

$ \begin{array}{ c c c c c c } \hline N_{IH} & N_{IH} &$	Symbol	Parameter	Conditions	V_{DD}	T _{amb} =	–40 °C	T _{amb} =	25 °C	T _{amb} = 85 °C		Unit
$\begin{array}{ c c c c c c c } \hline \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ $					Min	Max	Min	Max	Min	Max	
$\begin{array}{ c c c c c c }\hline V_{IL} & LOW-level input voltage \\ V_{IL} & LOW-level input voltage \\ \hline V_{IL} & LOW-level input voltage \\ \hline V_{IL} & LOW-level input voltage \\ \hline V_{OH} & 11.0 & - & 11.5 & - & 1.5 & - & 1.5 \\ \hline 10 \ V & - & 3.0 & - & 3.0 & - & 3.0 \\ \hline 15 \ V & - & 4.0 & - & 4.0 & - & 4.0 \\ \hline 15 \ V & - & 4.95 & - & 4.95 & - & 4.95 & - \\ \hline 10 \ V & 9.95 & - & 9.95 & - & 9.95 & - \\ \hline 10 \ V & 9.95 & - & 9.95 & - & 9.95 & - \\ \hline 15 \ V & 14.95 & - & 14.95 & - & 14.95 & - \\ \hline 10 \ V & - & 0.05 & - & 0.05 & - & 0.05 \\ \hline 15 \ V & - & 0.05 & - & 0.05 & - & 0.05 \\ \hline 15 \ V & - & 0.05 & - & 0.05 & - & 0.05 \\ \hline 15 \ V & - & 0.05 & - & 0.05 & - & 0.05 \\ \hline 15 \ V & - & 0.05 & - & 0.05 & - & 0.05 \\ \hline 15 \ V & - & 0.05 & - & 0.05 & - & 0.05 \\ \hline 15 \ V & - & 0.05 & - & 0.05 & - & 0.05 \\ \hline 10 \ V & - & 0.05 & - & 0.$	V _{IH}	HIGH-level input voltage	$ I_{O} < 1 \mu A$	5 V	3.5	-	3.5	-	3.5	-	V
$\begin{array}{c} V_{IL} \\ V_{OH} \\ V_{OH$				10 V	7.0	-	7.0	-	7.0	-	V
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$				15 V	11.0	-	11.0	-	11.0	-	V
$\begin{array}{ c c c c c c c c } \hline V_{OH} & HIGH-level output voltage \\ V_{OH} & HIGH-level output voltage \\ V_{OH} & HIGH-level output voltage \\ V_{OL} & V_$	V _{IL}	LOW-level input voltage	$ I_{O} < 1 \mu A$	5 V	-	1.5	-	1.5	-	1.5	V
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$				10 V	-	3.0	-	3.0	-	3.0	V
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$				15 V	-	4.0	-	4.0	-	4.0	V
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	V _{OH}	HIGH-level output voltage	$ I_{O} < 1 \mu A$	5 V	4.95	-	4.95	-	4.95	-	V
$\begin{array}{ c c c c c c c }\hline V_{OL} & LOW\mbox{-level output voltage} & Il_O < 1 \ \mu A \\ \hline & 5 \ V & - & 0.05 & - & 0.05 & - & 0.05 \\ \hline & 10 \ V & - & 0.05 & - & 0.05 & - & 0.05 \\ \hline & 15 \ V & - & 0.05 & - & 0.05 & - & 0.05 \\ \hline & 15 \ V & - & 0.05 & - & 0.05 & - & 0.05 \\ \hline & 15 \ V & - & -0.05 & - & 0.05 & - & 0.05 \\ \hline & 15 \ V & - & -1.7 & - & -1.4 & - & -1.1 \\ \hline & V_O = 4.6 \ V & 5 \ V & - & -0.52 & - & -0.44 & - & -0.36 \\ \hline & V_O = 9.5 \ V & 10 \ V & - & -1.3 & - & -1.1 & - & -0.9 \\ \hline & V_O = 9.5 \ V & 15 \ V & - & -3.6 & - & -3.0 & - & -2.4 \\ \hline & I_{OL} & LOW\mbox{-level output current} & V_O = 0.4 \ V & 5 \ V & 0.52 & - & 0.44 & - & 0.36 & - \\ \hline & V_O = 0.5 \ V & 10 \ V & 1.3 & - & 1.1 & - & 0.9 & - \\ \hline & V_O = 0.5 \ V & 15 \ V & 3.6 & - & 3.0 & - & 2.4 & - \\ \hline & I_{I} & \mbox{input leakage current} & I_{D} = 0 \ A & 5 \ V & - & 20 & - & 20 & - & 150 \\ \hline \end{array}$				10 V	9.95	-	9.95	-	9.95	-	V
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$				15 V	14.95	-	14.95	-	14.95	-	V
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	V _{OL}	LOW-level output voltage	$ I_{O} < 1 \mu A$	5 V	-	0.05	-	0.05	-	0.05	V
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$				10 V	-	0.05	-	0.05	-	0.05	V
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$				15 V	-	0.05	-	0.05	-	0.05	V
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	I _{OH}	HIGH-level output current	$V_0 = 2.5 \text{ V}$	5 V	-	-1.7	-	-1.4	-	-1.1	mA
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$			$V_0 = 4.6 \text{ V}$	5 V	-	-0.52	-	-0.44	-	-0.36	mA
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$			$V_0 = 9.5 \ V$	10 V	-	-1.3	-	-1.1	-	-0.9	mA
$ \frac{V_{O} = 0.5 \text{ V}}{V_{O} = 1.5 \text{ V}} \qquad \frac{10 \text{ V}}{15 \text{ V}} \qquad \frac{1.3}{3.6} \qquad - \qquad \frac{1.1}{3.0} \qquad - \qquad \frac{0.9}{2.4} \qquad - \\ \frac{I_{I}}{I_{DD}} \qquad \frac{1}{I_{O}} \qquad \frac{1}{I_{O}} = 0 \text{ A} \qquad \frac{1}{5} \text{ V} \qquad - \qquad \frac{1}{20} \qquad - \qquad \frac{1}{20} \qquad - \qquad \frac{1}{20} \qquad - \qquad \frac{1}{20} \qquad \frac{1}{150} $			$V_0 = 13.5 \text{ V}$	15 V	-	-3.6	-	-3.0	-	-2.4	mA
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	I _{OL}	LOW-level output current	$V_0 = 0.4 \ V$	5 V	0.52	-	0.44	-	0.36	-	mA
$\begin{array}{cccccccccccccccccccccccccccccccccccc$			$V_0 = 0.5 \ V$	10 V	1.3	-	1.1	-	0.9	-	mA
I_{DD} supply current $I_{O} = 0 \text{ A}$ 5 V - 20 - 20 - 150			$V_0 = 1.5 \text{ V}$	15 V	3.6	-	3.0	-	2.4	-	mA
	I _I	input leakage current		15 V	-	±0.3	-	±0.3	-	±1.0	μΑ
10 V - 40 - 40 - 300	I _{DD}	supply current	I _O = 0 A	5 V	-	20	-	20	-	150	μΑ
				10 V	-	40	-	40	-	300	μΑ
15 V - 80 - 80 - 600				15 V	-	80	-	80	-	600	μΑ
C _I input capacitance 7.5	Cı	input capacitance		-	-	-	-	7.5	-	-	pF

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11. Dynamic characteristics

Table 8. Dynamic characteristics

 $V_{SS} = 0 \text{ V; } T_{amb} = 25 \text{ °C; for test circuits see } \underline{Figure 6}$; unless otherwise specified.

t _{PHL}	HIGH to LOW							
–		A2 to Q18;	5 V	11 923 ns + (0.55 ns/pF)C _L	-	950	1900	ns
	propagation delay	see <u>Figure 5</u>	10 V	339 ns + (0.23 ns/pF)C _L	-	350	700	ns
			15 V	212 ns + (0.16 ns/pF)C _L	-	220	440	ns
		Qn to Qn + 1;	5 V	13 ns + (0.55 ns/pF)C _L	-	40	80	ns
		see Figure 5	10 V	4 ns + (0.23 ns/pF)C _L	-	15	30	ns
			15 V	2 ns + (0.16 ns/pF)C _L	-	10	20	ns
		MR to Qn	5 V	93 ns + (0.55 ns/pF)C _L	-	120	240	ns
			10 V	44 ns + (0.23 ns/pF)C _L	-	55	110	ns
			15 V	32 ns + (0.16 ns/pF)C _L	-	40	80	ns
		A1 to Y1; see Figure 5	5 V	63 ns + (0.55 ns/pF)C _L	-	90	180	ns
			10 V	24 ns + (0.23 ns/pF)C _L	-	35	70	ns
			15 V	17 ns + (0.16 ns/pF)C _L	CL - 350 700 n CL - 220 440 n CL - 40 80 n CL - 15 30 n CL - 10 20 n CL - 120 240 n CL - 55 110 n CL - 40 80 n CL - 90 180 n CL - 35 70 n CL - 25 50 n CL - 25 50 n CL - 350 700 n CL - 15 30 n CL - 10 20 n CL - 15 30 n CL - 10 20 n CL - 10 20 n CL - 60 120 n CL - 30 60 n CL - 20 40 n CL - 30 60 n CL - 20 40 n A0 20 - n	ns		
t _{PLH}	LOW to HIGH	A2 to Q18; see <u>Figure 5</u>	5 V	11 923 ns + (0.55 ns/pF)C _L	-	950	1900	ns
	propagation delay		10 V	339 ns + (0.23 ns/pF)C _L	-	350	700	ns
			15 V	212 ns + (0.16 ns/pF)C _L	-	220	440	ns
		Qn to Qn + 1;	5 V	13 ns + (0.55 ns/pF)C _L	-	40	80	ns
		see Figure 5	10 V	4 ns + (0.23 ns/pF)C _L	-	15	30	ns
			15 V	2 ns + (0.16 ns/pF)C _L	-	10	20	ns
		A1 to Y1;	5 V	33 ns + (0.55 ns/pF)C _L	-	60	120	ns
		see Figure 5	10 V	19 ns + (0.23 ns/pF)C _L	-	30	60	ns
			15 V	12 ns + (0.16 ns/pF)C _L	-	20	40	ns
t _t	transition time	Qn; see Figure 5	5 V	10 ns + (1.00 ns/pF)C _L	-	60	120	ns
			10 V	9 ns + (0.42 ns/pF)C _L	-	30	60	ns
			15 V	6 ns + (0.28 ns/pF)C _L	-	20	40	ns
t _W	pulse width	A2 HIGH;	5 V		80	40	-	ns
		minimum width;	10 V		40	20	-	ns
		see <u>Figure 5</u>	15 V		30	15	-	ns
		MR HIGH;	5 V		70	35	-	ns
		minimum width;	10 V		40	20	-	ns
		see Figure 5	15 V		30	15	-	ns
t _{rec}	recovery time	MR; see Figure 5	5 V		+20	-10	-	ns
			10 V		+15	-5	-	ns
			15 V		15	0	-	ns
f _{max}	maximum frequency	A1; see Figure 5	5 V		6	12	-	MHz
			10 V		12	25	-	MHz
			15 V		17	35	-	MHz

^[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C_L in pF).

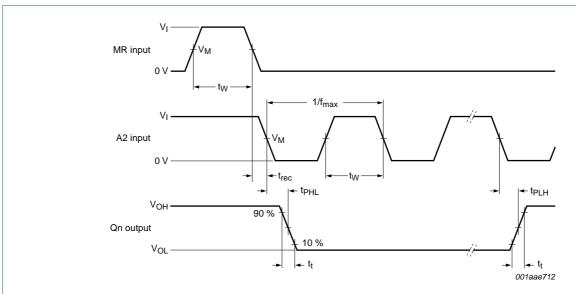
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Table 9. Dynamic power dissipation P_D

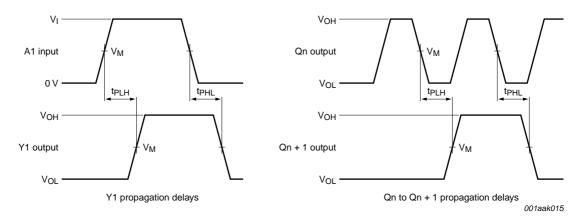
 P_D can be calculated from the formulas shown. $V_{SS} = 0 \text{ V}$; $t_r = t_f \le 20 \text{ ns}$; $T_{amb} = 25 \text{ °C}$.

Symbol	Parameter	V_{DD}	Typical formula for P _D (μW)	where:
P_D	dynamic power	5 V	$P_D = 1200 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$	f_i = input frequency in MHz,
	dissipation	10 V	$P_D = 5100 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$	f_0 = output frequency in MHz,
		15 V	$P_D = 13050 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$	C_L = output load capacitance in pF,
				V _{DD} = supply voltage in V,
				$\Sigma(C_L \times f_o)$ = sum of the outputs.

12. Waveforms



a. Pulse widths, maximum frequency, recovery and transition times and A2 to Qn propagation delays



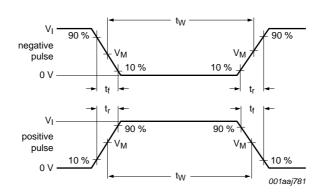
b. A1 to Y1, MR to Qn and Qn to Qn + 1 propagation delays

Measurement points are given in Table 10.

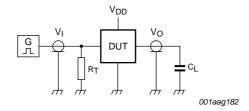
The logic levels V_{OH} and V_{OL} are typical output voltage levels that occur with the output load.

Fig 5. Waveforms showing measurement of dynamic characteristics

24-stage frequency divider and oscillator



a. Input waveforms



b. Test circuit

Test data is given in Table 10.

Definitions for test circuit:

Device Under Test (DUT);

C_L = Load capacitance including jig and probe capacitance;

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

Fig 6. Test circuit for switching times

Table 10. Measurement points and test data

Supply voltage	Input	Load		
	V _I	V _M	t _r , t _f	CL
5 V to 15 V	V_{DD}	0.5V _I	≤ 20 ns	50 pF

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13. Application information

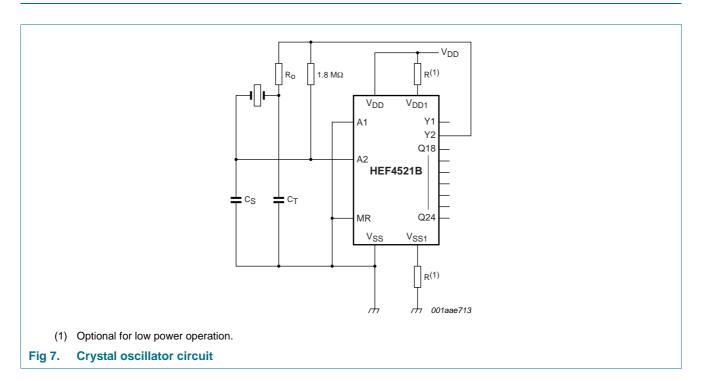
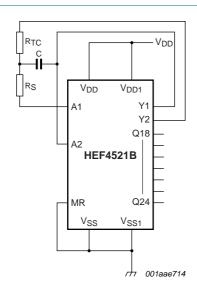


Table 11. Typical characteristics for crystal oscillator See *Figure 7*.

Parameter	500 kHz circuit	50 kHz circuit	Unit
Crystal characteristics			
Resonance frequency	500	50	kHz
Crystal cut	S	N	-
Equivalent resistance; R _S	1	6.2	kΩ
External resistor/capacitor values			
R _o	47	750	kΩ
Ст	82	82	pF
C _S	20	20	pF

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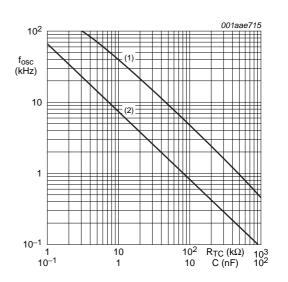
$$f\!\approx\!\frac{1}{2.3\times R_{TC}\times C}$$
 ; $R_S\!\geq\!2R_{TC}$, where:

f is in Hz, R is in $\Omega,$ and C is in F.

$$R_S + R_{TC} < \frac{V_{IL(max)}}{I_{IJ}}$$
 , where:

 $V_{IL(max)}$ = maximum input voltage LOW; and I_{LI} = input leakage current.

Fig 8. RC oscillator circuit

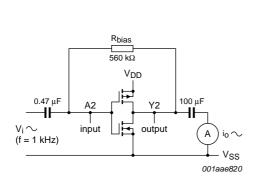


 V_{DD} = 10 V; The test circuit is shown in Figure 8.

- (1) R_{TC} ; C = 1 nF; $R_S \approx 2$ R_{TC} .
- (2) C; $R_{TC} = 56 \text{ k}\Omega$; $R_S = 120 \text{ k}\Omega$.

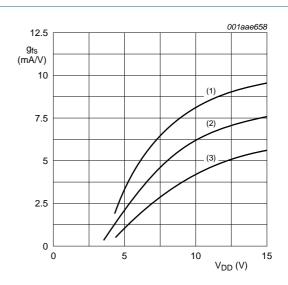
Fig 9. Oscillator frequency as a function of $R_{\mbox{\scriptsize TC}}$ and $\mbox{\scriptsize C}$

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 $g_{fs} = d_{io}/d_{vi}$ with v_o constant (see Figure 11).

Fig 10. Test setup for measuring forward transconductance



- (1) Average + 2s.
- (2) Average.
- (3) Average 2s.

 Where 's' is the observed standard deviation.

Fig 11. Typical forward transconductance g_{fs} as a function of the supply voltage at T_{amb} = 25 °C

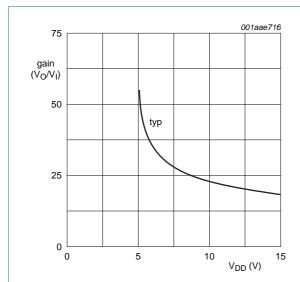


Fig 12. Voltage gain V_0/V_1 as a function of supply voltage

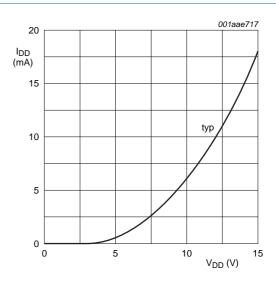


Fig 13. Supply current as a function of supply voltage

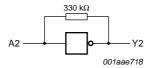


Fig 14. Test setup for measuring the Figure 12 and Figure 13 graphs

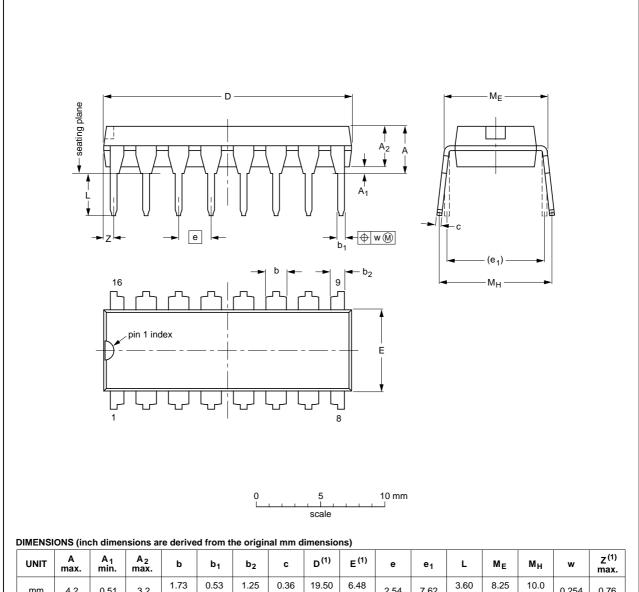
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24-stage frequency divider and oscillator

14. Package outline

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



				,												
UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.02	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.1	0.3	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.03

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

PROJECTION ISSUE DATE	
	,,E
95-01-14 03-02-13	
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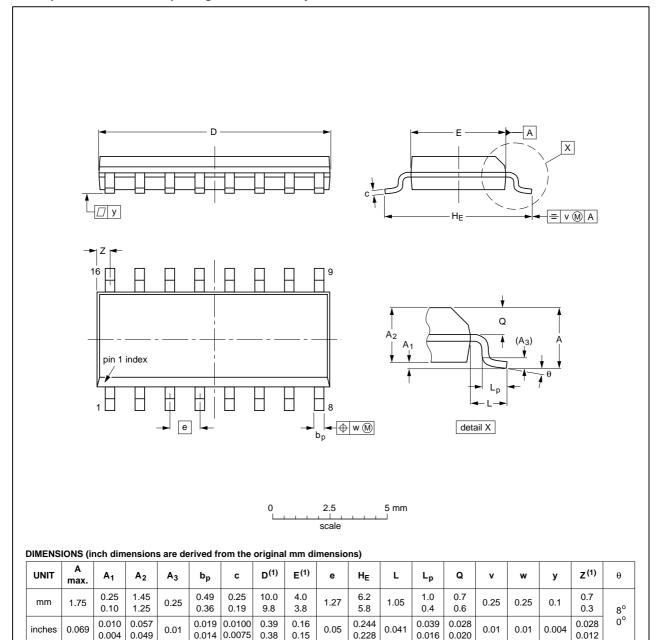
Fig 15. Package outline SOT38-4 (DIP16)

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SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT109-1	076E07	MS-012				99-12-27 03-02-19

Fig 16. Package outline SOT109-1 (SO16)

HEF4521

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15. Revision history

Table 12. Revision history

	•				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
HEF4521B v.6	20111121	Product data sheet	-	HEF4521B v.5	
Modifications:	 Section App 	olications removed			
 <u>Table 4</u>: added references to <u>Table note [1]</u> and <u>Table note [2]</u> <u>Table 7</u>: I_{OH} minimum values changed to maximum 					
HEF4521B v.5	20091105	Product data sheet	-	HEF4521B v.4	
HEF4521B v.4	20090421	Product data sheet	-	HEF4521B_CNV v.3	
HEF4521B_CNV v.3	19950101	Product specification	-	HEF4521B_CNV v.2	
HEF4521B_CNV v.2	19950101	Product specification	-	-	

24-stage frequency divider and oscillator

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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HEF4521B NXP Semiconductors 24-stage frequency divider and oscillator

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